



# NEC's 1 W ULTRA SMALL SPDT SWITCH

## UPG2030TK

### FEATURES

- **SWITCH CONTROL VOLTAGE:**  
 $V_{\text{cont}}(\text{H}) = 2.7 \text{ to } 3.0 \text{ V}$  (2.8 V TYP.)  
 $V_{\text{cont}}(\text{L}) = -0.2 \text{ to } +0.2 \text{ V}$  (0 V TYP.)
- **LOW INSERTION LOSS:**  
 0.25 dB TYP. @ 0.5 to 1.0 GHz  
 0.30 dB TYP. @ 1.0 to 2.0 GHz  
 0.35 dB TYP. @ 2.0 to 2.5 GHz
- **HIGH ISOLATION:**  
 27 dB TYP. @ 0.5 to 2.0 GHz  
 24 dB TYP. @ 2.0 to 2.5 GHz
- **POWER HANDLING:**  
 $P_{\text{in}}(0.1 \text{ dB}) = +27.0 \text{ dBm TYP. @ } 2.0 \text{ GHz, } V_{\text{cont}} = 2.8 \text{ V/0 V}$   
 $P_{\text{in}}(1 \text{ dB}) = +30.0 \text{ dBm TYP. @ } 2.0 \text{ GHz, } V_{\text{cont}} = 2.8 \text{ V/0 V}$   
 (Reference value)
- **HIGH-DENSITY SURFACE MOUNTING:**  
 6-pin minimold package (1.5 × 1.1 × 0.55 mm)
- **PB-FREE**

### DESCRIPTION

NEC's UPG2030TK is a GaAs MMIC L, S-band SPDT (Single Pole Double Throw) switch for mobile phone and L, S-band applications.

This device has low insertion loss and high isolation, and can operate from 0.5 to 3 GHz at 2.7 to 3.0 V.

This device is housed in a 6-pin low profile, Pb-Free minimold package and this package is also suitable for high-density surface mounting.

### APPLICATIONS

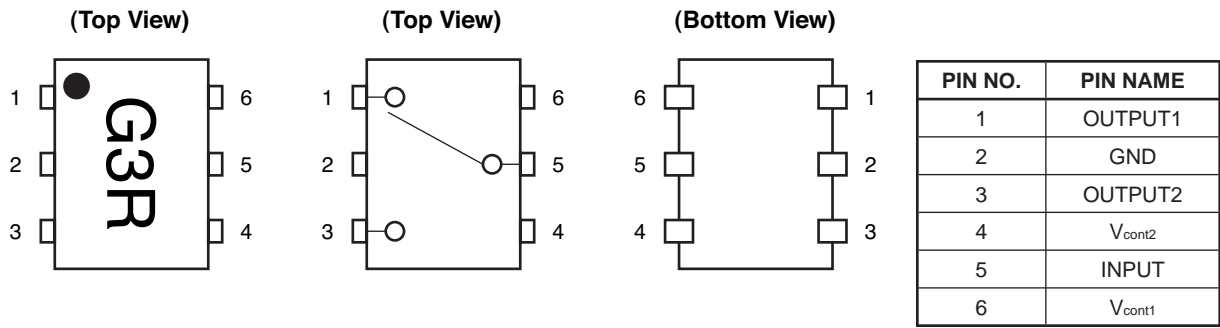
- CELLULAR AND CORDLESS HANDSETS
- PCS, BLUETOOTH™, WLAN, AND WLL
- SHORT RANGE WIRELESS

### ORDERING INFORMATION

| PART NUMBER    | PACKAGE                         | MARKING | SUPPLYING FORM   |
|----------------|---------------------------------|---------|--|
| UPG2030TK-E2-A | 6-pin lead-less minimold (1511) | G3R     | <ul style="list-style-type: none"> <li>• Embossed tape 8 mm wide</li> <li>• Pin 1, 6 face the perforation side of the tape</li> <li>• Qty 5 kpcs/reel</li> </ul> |

**Remark** To order evaluation samples, contact your nearby sales office.  
 Part number for sample order: UPG2030TK-A

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



TRUTH TABLE

| V <sub>CONT1</sub> | V <sub>CONT2</sub> | INPUT-OUTPUT1 | INPUT-OUTPUT2 |
|--------------------|--------------------|---------------|---------------|
| Low                | High               | ON            | OFF           |
| High               | Low                | OFF           | ON            |

ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> =+25°C, unless otherwise specified)

| PARAMETER                     | SYMBOL            | RATINGS     | UNIT |
|-------------------------------|-------------------|-------------|------|
| Switch Control Voltage        | V <sub>cont</sub> | 6.0         | V    |
| Input Power                   | P <sub>in</sub>   | +33         | dBm  |
| Operating Ambient Temperature | T <sub>A</sub>    | -45 to +85  | °C   |
| Storage Temperature           | T <sub>stg</sub>  | -55 to +150 | °C   |

RECOMMENDED OPERATING RANGE (T<sub>A</sub> =+25°C, unless otherwise specified)

| PARAMETER                  | SYMBOL                | MIN. | TYP. | MAX. | UNIT |
|----------------------------|-----------------------|------|------|------|------|
| Switch Control Voltage (H) | V <sub>cont</sub> (H) | 2.7  | 2.8  | 3.0  | V    |
| Switch Control Voltage (L) | V <sub>cont</sub> (L) | -0.2 | 0    | 0.2  | V    |

**ELECTRICAL CHARACTERISTICS**(TA = +25°C, V<sub>cont</sub> = 2.8V/0 V, DC blocking capacitors = 56 pF, unless otherwise specified)

| PARAMETER  | SYMBOL                   | TEST CONDITIONS    | MIN.  | TYP.  | MAX. | UNIT |
|--|--------------------------|--------------------|-------|-------|------|------|
| Insertion Loss 1                                       | L <sub>INS1</sub>        | f = 0.5 to 1.0 GHz | –     | 0.25  | 0.45 | dB   |
| Insertion Loss 2                                       | L <sub>INS2</sub>        | f = 1.0 to 2.0 GHz | –     | 0.30  | 0.50 | dB   |
| Insertion Loss 3                                       | L <sub>INS3</sub>        | f = 2.0 to 2.5 GHz | –     | 0.35  | 0.55 | dB   |
| Isolation 1  | ISL <sub>1</sub>         | f = 0.5 to 2.0 GHz | 23    | 27    | –    | dB   |
| Isolation 2  | ISL <sub>2</sub>         | f = 2.0 to 2.5 GHz | 20    | 24    | –    | dB   |
| Input Return Loss                                      | RL <sub>in</sub>         | f = 0.5 to 2.5 GHz | 15    | 20    | –    | dB   |
| Output Return Loss                                     | RL <sub>out</sub>        | f = 0.5 to 2.5 GHz | 15    | 20    | –    | dB   |
| 0.1 dB Gain Compression<br>Input Power <sup>Note</sup> | P <sub>in (0.1 dB)</sub> | f = 2.0 GHz        | +25.5 | +27.0 | –    | dBm  |
|  |                          | f = 2.5 GHz        | +25.5 | +27.0 | –    | dBm  |
| Switch Control Current                                 | I <sub>cont</sub>        | No signal          | –     | 4     | 20   | μA   |
| Switch Control Speed                                   | t <sub>sw</sub>          |                    | –     | 50    | 500  | ns   |

**Notes** P<sub>in (0.1 dB)</sub> is the measured input power level when the insertion loss increases 0.1 dB more than that of linear range.

**STANDARD CHARACTERISTICS FOR REFERENCE**(TA = +25°C, V<sub>cont</sub> = 2.8 V/0 V, DC blocking capacitors = 56 pF, unless otherwise specified)

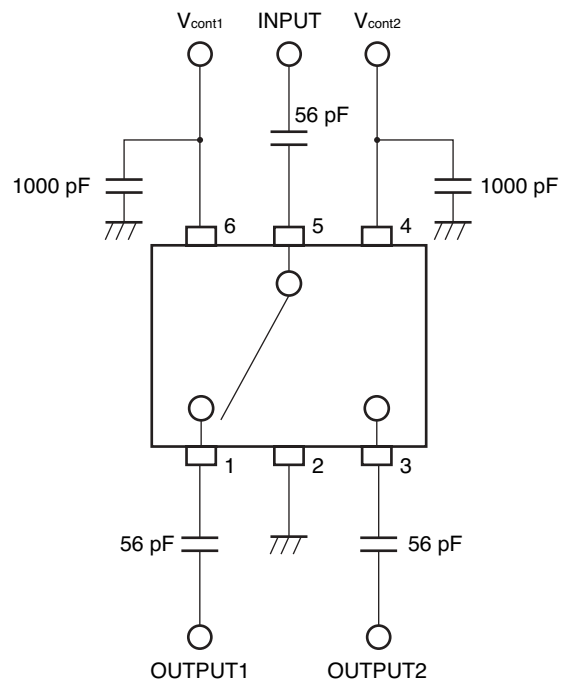
| PARAMETER  | SYMBOL                 | TEST CONDITIONS | MIN. | TYP.  | MAX. | UNIT |
|--|------------------------|-----------------|------|-------|------|------|
| 1 dB Gain Compression<br>Input Power <sup>Note</sup> | P <sub>in (1 dB)</sub> | f = 2.0 GHz     | –    | +30.0 | –    | dBm  |

**Notes** P<sub>in (1 dB)</sub> is the measured input power level when the insertion loss increases 1 dB more than that of linear range.

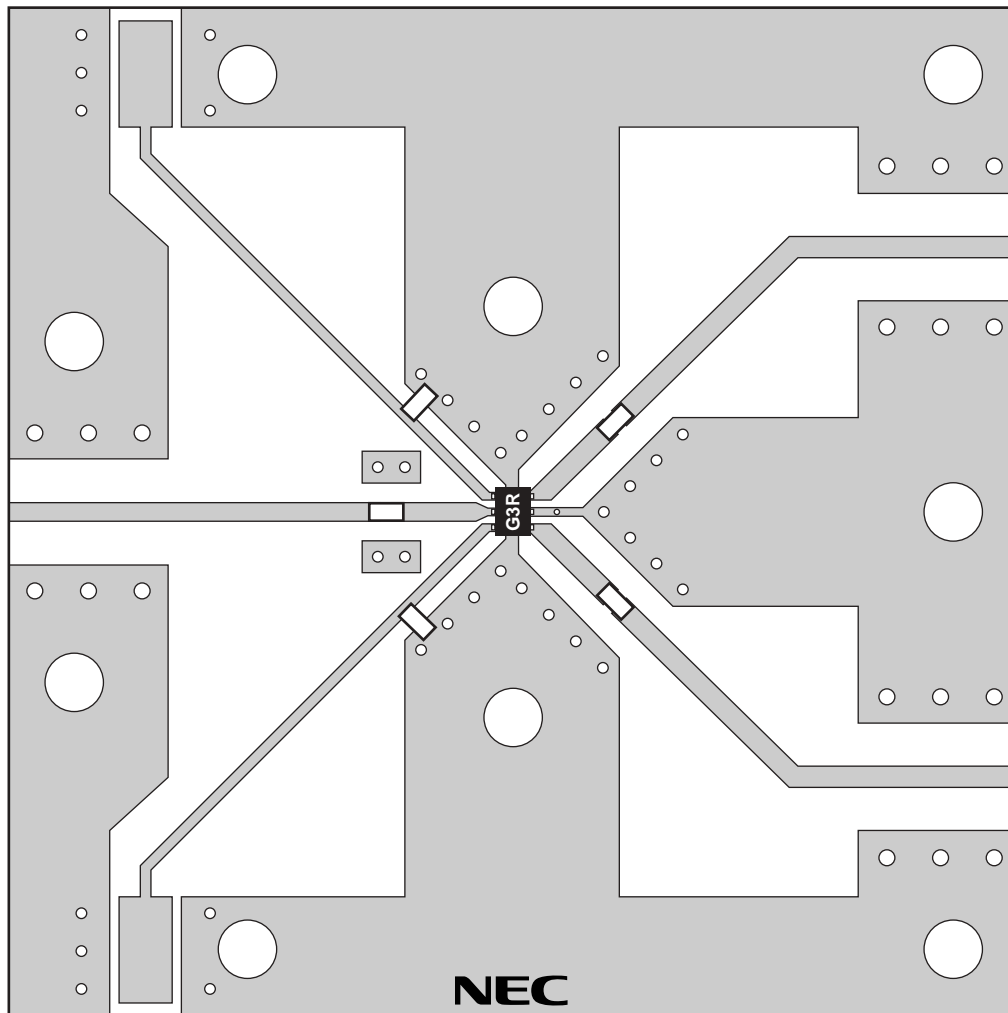
**Caution** It is necessary to use DC blocking capacitors with this device.

The value of DC blocking capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with the actual board of your system. The range of recommended DC blocking capacitor value is less than 100 pF for frequencies above 0.5 GHz, and 1,000 pF for frequencies below 0.5 GHz.

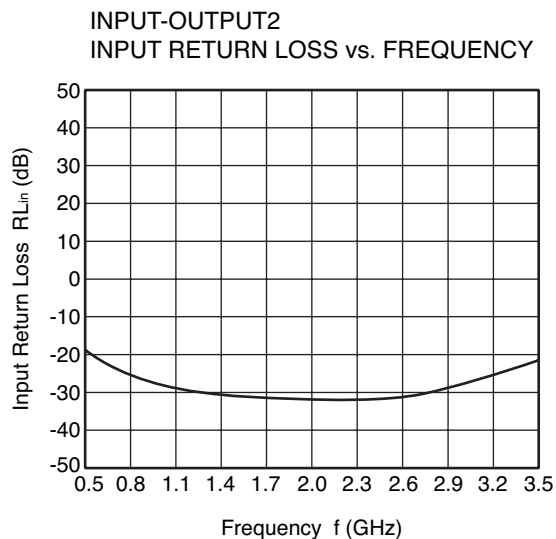
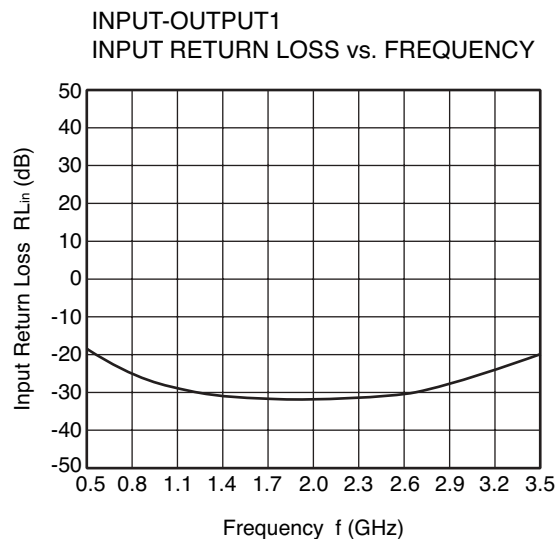
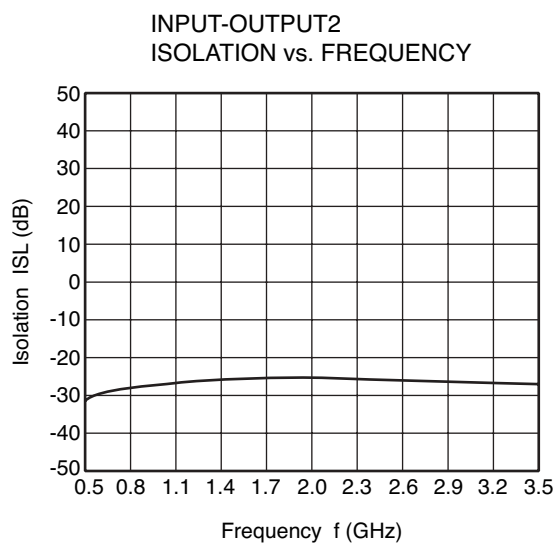
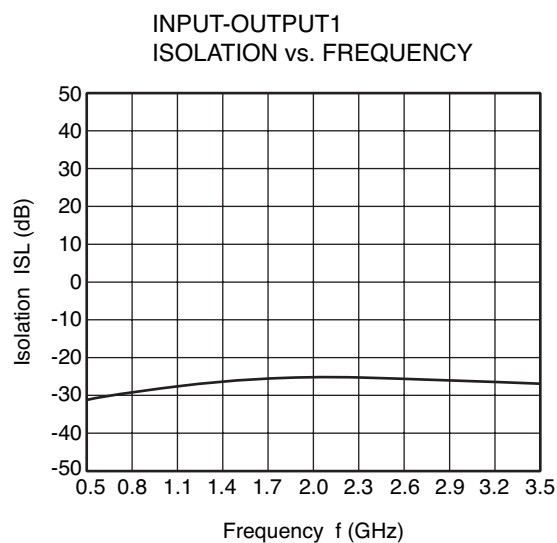
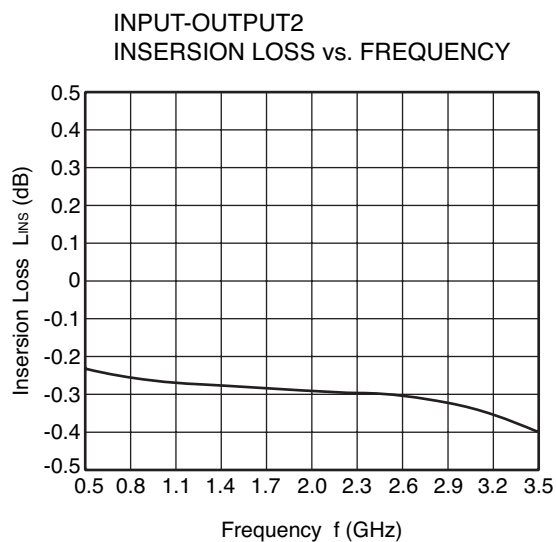
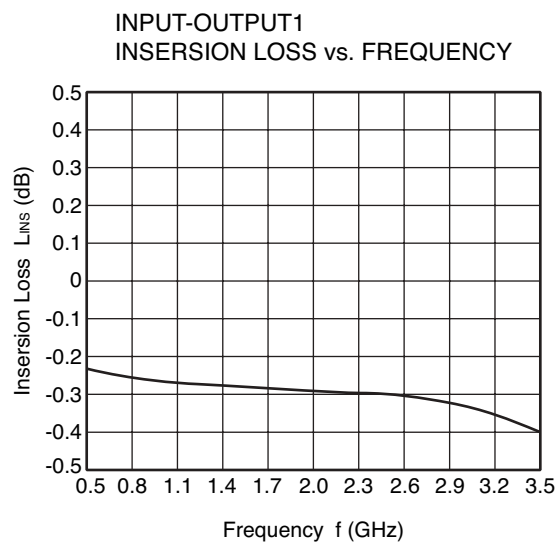
**EVALUATION CIRCUIT** ( $V_{\text{cont}} = 2.8 \text{ V/0 V}$ , DC blocking capacitors = 56 pF)



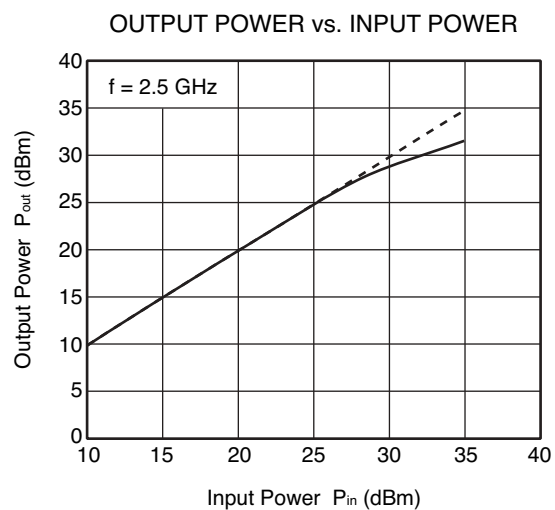
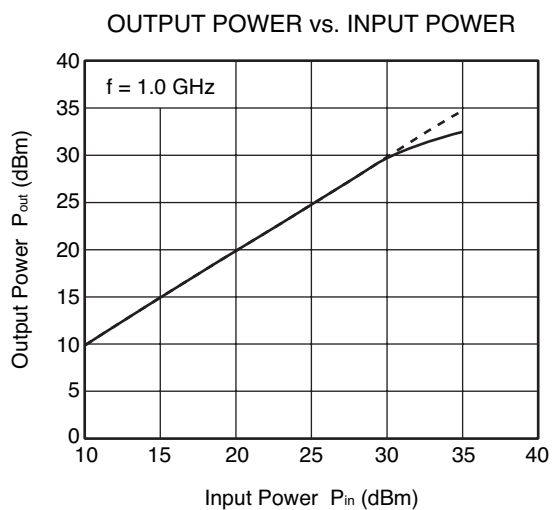
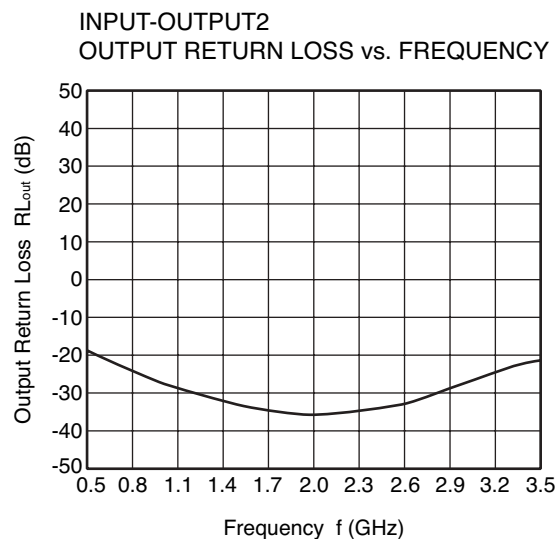
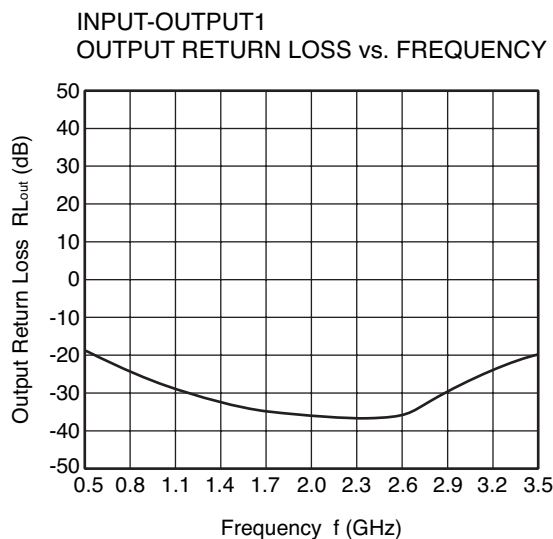
The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

**ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD****USING THE NEC EVALUATION BOARD**

| SYMBOL     | VALUES  |
|------------|---------|
| C1, C2, C3 | 56 pF   |
| C4, C5     | 1000 pF |

**TYPICAL CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$ ,  $V_{\text{cont}} = 2.8 \text{ V/0 V}$ , DC blocking capacitors = 56 pF, unless otherwise specified)

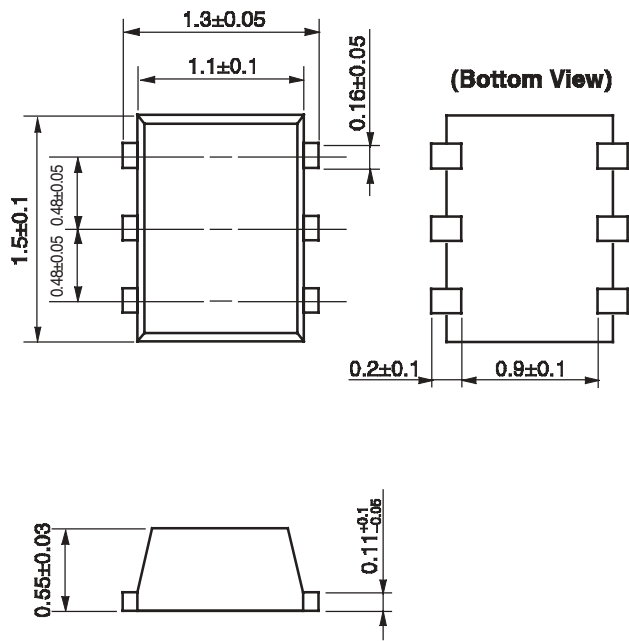
**Remark** The graphs indicate nominal characteristics.

**TYPICAL CHARACTERISTICS** ( $T_A = +25^\circ\text{C}$ ,  $V_{\text{cont}} = 2.8 \text{ V/0 V}$ , DC blocking capacitors = 56 pF, unless otherwise specified)


**Remark** The graphs indicate nominal characteristics.

PACKAGE DIMENSIONS

6-PIN LEAD-LESS MINIMOLD (1511) (UNIT:mm)



Remark ( ) : Reference value



## RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method | Soldering Conditions  | Condition Symbol |
|------------------|---|------------------|
| Infrared Reflow  | Peak temperature (package surface temperature) : 260°C or below<br>Time at peak temperature : 10 seconds or less<br>Time at temperature of 220°C or higher : 60 seconds or less<br>Preheating time at 120 to 180°C : 120±30 seconds<br>Maximum number of reflow processes : 3 times<br>Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below | IR260            |
| VPS              | Peak temperature (package surface temperature) : 215°C or below<br>Time at temperature of 200°C or higher : 25 to 40 seconds<br>Preheating time at 120 to 150°C : 30 to 60 seconds<br>Maximum number of reflow processes : 3 times<br>Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below  | VP215            |
| Wave Soldering   | Peak temperature (molten solder temperature) : 260°C or below<br>Time at peak temperature : 10 seconds or less<br>Preheating temperature (package surface temperature) : 120°C or below<br>Maximum number of flow processes : 1 time<br>Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below  | WS260            |
| Partial Heating  | Peak temperature (pin temperature) : 350°C or below<br>Soldering time (per side of device) : 3 seconds or less<br>Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below  | HS350            |

**Caution** Do not use different soldering methods together (except for partial heating).